



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent application of

Takaaki Sasaki : Group Art Unit 2818

Serial No. 09/689,824 : Examiner Renee R. Berry

Filed October 13, 2000

SEMICONDUCTOR DEVICE, SEMICONDUCTOR PACKAGE FOR USE THEREIN, AND MANUFACTURING METHOD THEREOF

## SUPPLEMENTAL AMENDMENT

Honorable Commissioner For Patents Washington, D.C. 20231

Sir:

Supplemental to the Amendment filed March 21, 2002, the following

additional amendments and remarks are submitted:

REÇEIVED MAY 23 2002

In the Claims<sup>1</sup>

Kindly rewrite Claim 7 to read as follows:

7. (Twice amended) A method of manufacturing a semiconductor device with a semiconductor element fixed to a semiconductor package, comprising the steps of:

<sup>&</sup>lt;sup>1</sup> A copy of any revised claims showing additions and deletions thereto is attached as ATTACHMENT "A".